Product data sheet

1. General description

Epitaxial, medium-speed switching, double diode in a small SOT23 Surface-Mounted Device (SMD) plastic package. The diodes are connected in series.

2. Features and benefits

- Plastic SMD package
- Low leakage current: typ. 3 pA
- · Switching time: typ. 0.8 us
- · Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 85 V
- · Repetitive peak forward current: max. 500 mA.
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

· Low-leakage current applications in surface mounted circuits.

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V _R	reverse voltage		-	-	75	V
I _R	reverse current	V _R = 75 V; T _j = 150 °C	-	3	80	nA



Low-leakage double diode

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)	3	K1, A2
2	K2	cathode (diode 2)		
3	K1, A2	cathode (diode 1) and anode (diode 2)	SOT23	A1 K2 006aaa763

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAV199-Q		plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	SOT23

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
BAV199-Q	JY%

[1] % = placeholder for manufacturing site code

Low-leakage double diode

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V _R	reverse voltage			-	75	V
V_{RRM}	repetitive peak reverse voltage			-	85	V
l _F	forward current	single diode loaded		-	160	mA
		double diode loaded		-	140	mA
I _{FRM}	repetitive peak forward current			-	500	mA
I _{FSM}	non-repetitive peak	t _p = 1 μs; square wave; T _{j(init)} = 25 °C		-	4	Α
	forward current	t _p = 1 ms; square wave; T _{j(init)} = 25 °C		-	1	Α
		t _p = 1 s; square wave; T _{j(init)} = 25 °C		-	0.5	Α
Per device;	one diode loaded			1	'	'
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	250	mW
Тј	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	single diode loaded; in free air	[1]	-	-	500	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	-	360	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

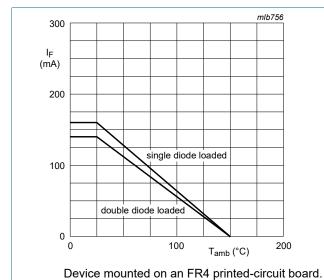
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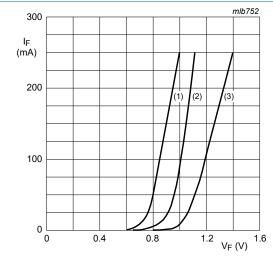
10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V _F	forward voltage	I _F = 1 mA; T _j = 25 °C	-	-	900	mV
		I _F = 10 mA; T _j = 25 °C	-	-	1	V
		I _F = 50 mA; T _j = 25 °C	-	-	1.1	V
		I _F = 150 mA; T _j = 25 °C	-	-	1.25	V
I _R	reverse current	V _R = 75 V; T _j = 25 °C	-	0.003	5	nA
		V _R = 75 V; T _j = 150 °C	-	3	80	nA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _j = 25 °C	-	2	-	pF
t _{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; $I_{R(meas)}$ = 1 mA; I_{L} = 100 Ω ; I_{amb} = 25 °C	-	0.8	3	μs
V_{FRM}	peak forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{amb} = 25 \text{ °C}$	-	-	1.75	V



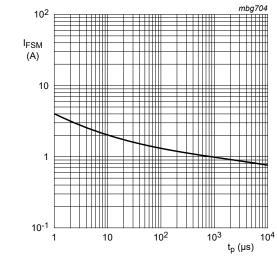
Maximum permissible continuous forward current as a function of ambient temperature.



- (1) T_{amb} = 150 °C; typical values (2) T_{amb} = 25 °C; typical values (3) T_{amb} = 25 °C; maximum values

Fig. 2. Forward current as a function of forward voltage; per diode

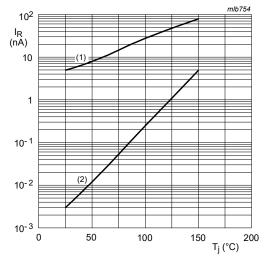
Low-leakage double diode



Based on square wave currents.

 $T_{j(init)} = 25 \degree C$

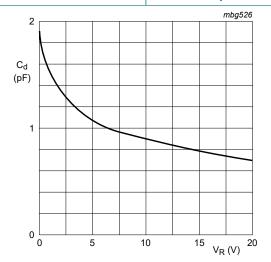
Fig. 3. Non-repetitive peak forward current as a function of pulse duration; typical values



V_R = 75 V

- (1) Maximum values
- (2) Typical values

Fig. 4. Reverse current as a function of junction temperature

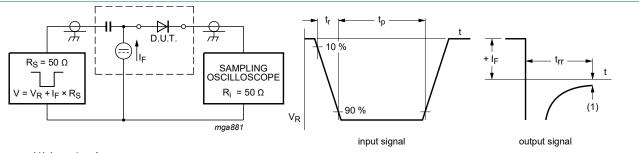


f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values

Low-leakage double diode

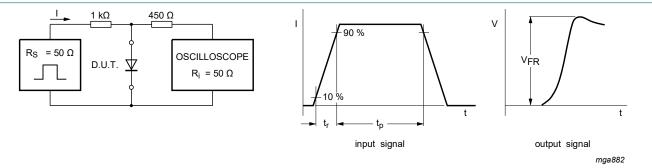
11. Test information



(1) $I_R = 1 \text{ mA}$

Input signal: reverse pulse rise time t_r = 0.6 ns; reverse voltage pulse duration t_p = 100 ns; duty cycle δ = 0.05 Oscilloscope: rise time t_r = 0.35 ns

Fig. 6. Reverse recovery time test circuit and waveforms



Input signal: forward pulse rise time t_r = 20 ns; forward current pulse duration $t_p \ge 100$ ns; duty cycle $\delta \le 0.005$

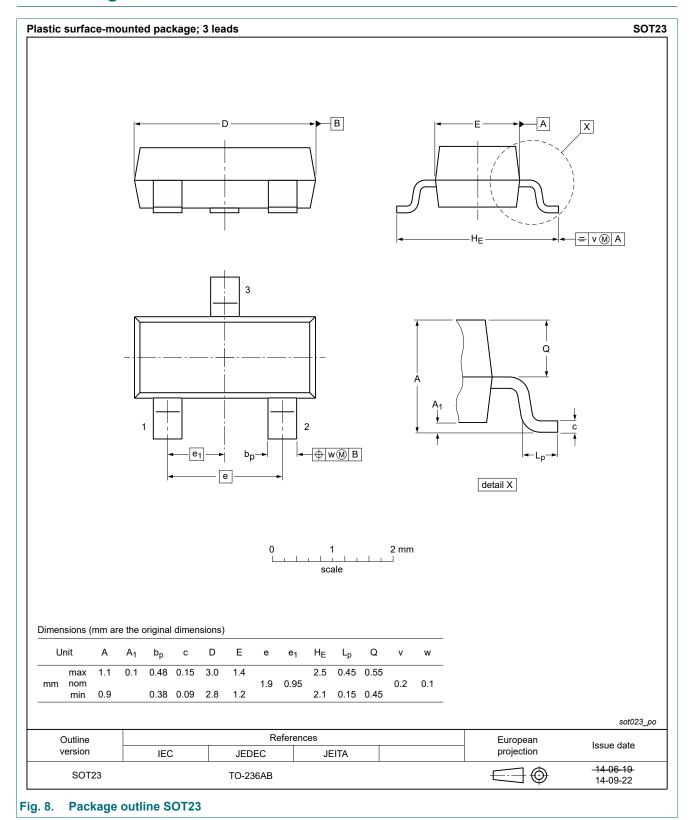
Fig. 7. Forward recovery voltage test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

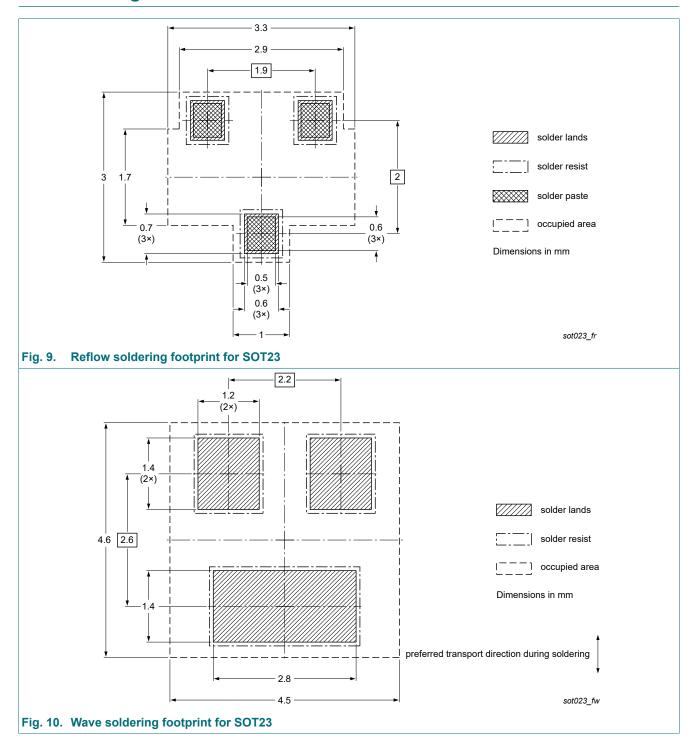
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12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAV199-Q v.1	20210823	Product data sheet	-	-

Low-leakage double diode

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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